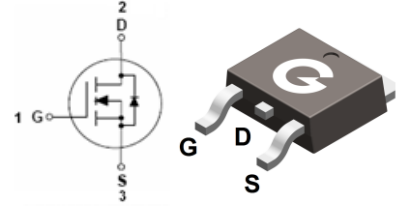


### Features

- Low gate charge minimize switching loss
- Fast recovery body diode
- RoHS compliant with Halogen-free

HF



TO-252

### Mechanical Data

- Case: TO-252
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208

### Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
BL2N100D	TO-252	80 pcs / Tube & 2500 pcs / Tape & Reel	2N100D

### Maximum Ratings (@ $T_C = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	$V_{DSS}$	1000	V
Gate-to-Source Voltage	$V_{GSS}$	$\pm 30$	V
Continuous Drain Current	$I_D$	2	A
Pulsed Drain Current ( $V_{GS} = 10\text{V}$ )	$I_{DM}$	8	A
Single Pulse Avalanche Energy <sup>**1</sup>	$E_{AS}$	24	mJ

### Thermal Characteristics

Parameter	Symbol	Value	Unit
Power Dissipation ( $T_C = 25^\circ\text{C}$ )	$P_D$	60	W
Thermal Resistance Junction-to-Air	$R_{\theta JA}$	75	$^\circ\text{C}/\text{W}$
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	2.08	$^\circ\text{C}/\text{W}$
Operating Junction Temperature Range	$T_J$	-55 ~ +150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

### Electrical Characteristics (@ $T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
$V_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 1mA$	1000	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 1000V, V_{GS} = 0V$	-	-	1	$\mu A$
		$V_{DS} = 800V, V_{GS} = 0V, T_J = 125^\circ\text{C}$	-	-	250	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$R_{DS(ON)}$	Static Drain-Source On-resistance	$V_{GS} = 10V, I_D = 1A$	-	-	10	$\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	2	-	4	V
gfs	Forward Threshold Voltage	$V_{DS} = 15V, I_D = 2A$	-	2.5	-	S
<b>Dynamic Characteristics</b>						
$C_{ISS}$	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1.0MHz$	-	380	-	pF
$C_{OSS}$	Output Capacitance		-	40	-	
$C_{RSS}$	Reverse Transfer Capacitance		-	4	-	
<b>Switching Characteristics</b>						
$t_{d(ON)}$	Turn-on Delay Time	$V_{DS} = 500V$ $R_G = 12\Omega$ $I_D = 2A$ $V_{GS} = 10V$	-	8	-	ns
$t_r$	Turn-on Rise Time		-	6	-	
$t_{d(OFF)}$	Turn-Off Delay Time		-	36	-	
$t_f$	Turn-Off Fall Time		-	15	-	
$Q_G$	Total Gate-Charge	$V_{DS} = 500V$ $V_{GS} = 10V$ $I_D = 2A$	-	15	-	nC
$Q_{GS}$	Gate to Source Charge		-	2.1	-	
$Q_{GD}$	Gate to Drain (Miller) Charge		-	6	-	
<b>Source-Drain Diode Characteristics</b>						
$V_{SD}$	Diode Forward Voltage	$I_{SD} = 2A, V_{GS} = 0V$	-	-	1.5	V
$I_S$	Continuous Source Current		-	-	2	A
$I_{SM}$	Maximum Pulsed Current		-	-	8	A
$t_{rr}$	Reverse Recovery Time	$I_S = I_F, V_{GS} = 0V$ $dI_{SD}/dt = 100A/\mu s$	-	320	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	1000	-	nC

Note 1: The  $E_{AS}$  test condition is  $V_{DS} = 50V, V_{GS} = 15V, L = 10mH$

Ratings and Characteristics Curves (@  $T_A = 25^\circ\text{C}$  unless otherwise specified)

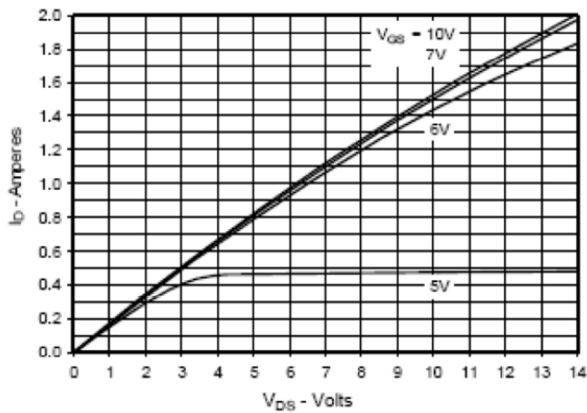


Fig 1 Typical Output Characteristics

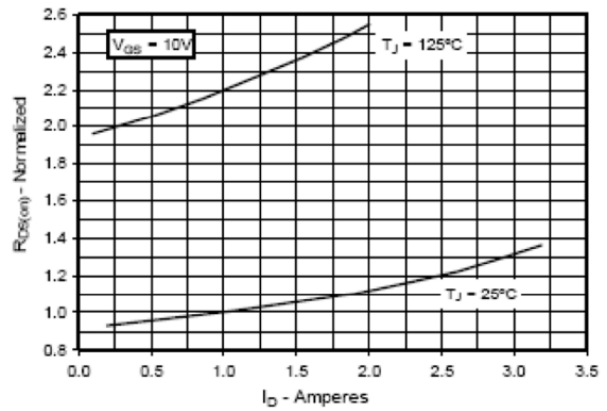


Fig 2 On-Resistance vs. Drain Current and Gate Voltage

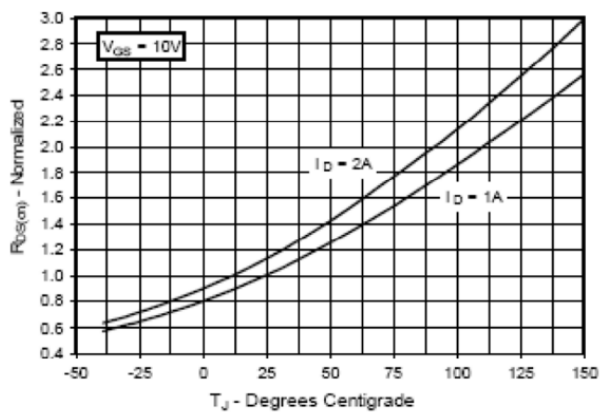


Fig 3 On-Resistance vs. Junction Temperature

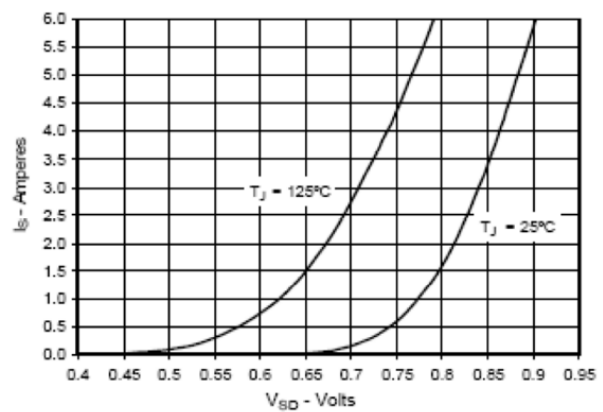


Fig 4 Body-Diode Characteristics

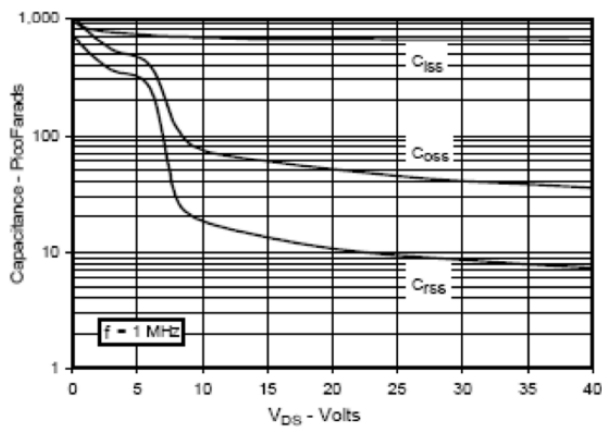


Fig 5 Capacitance Characteristics

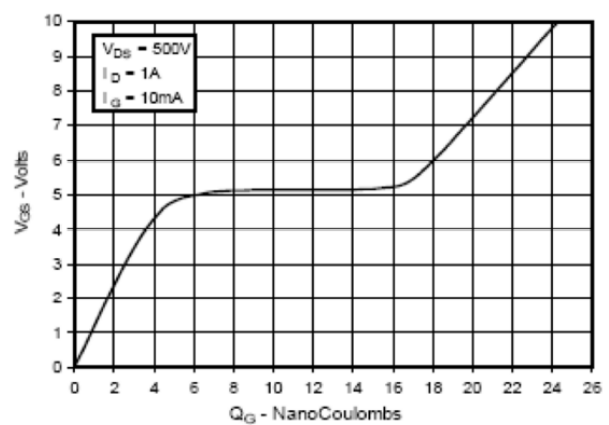
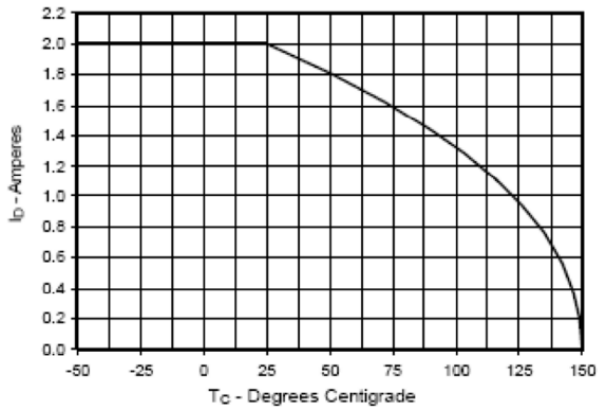
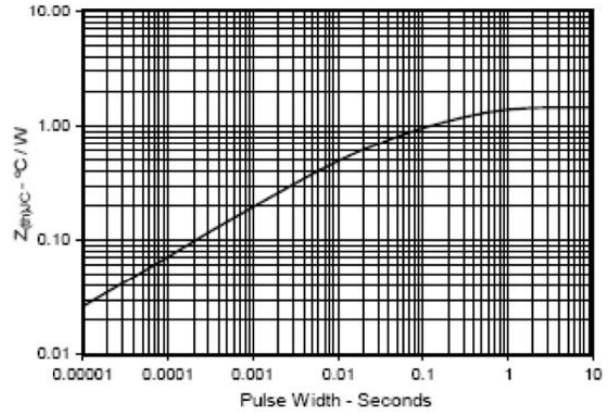


Fig 6 Gate-Charge Characteristics

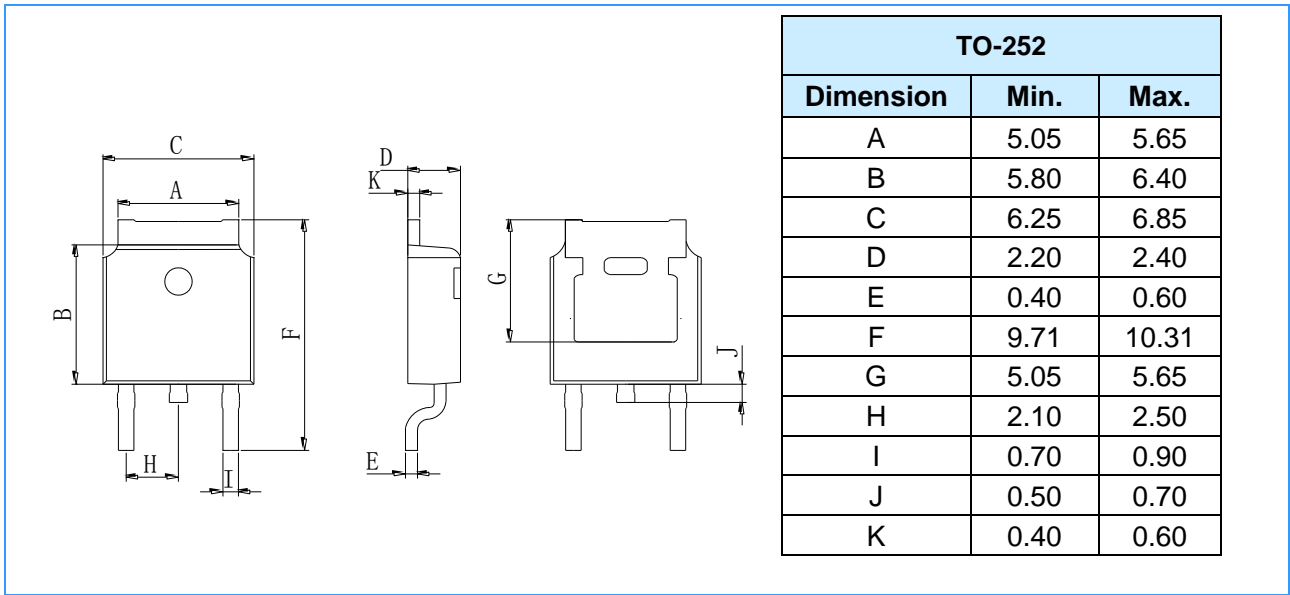


**Figure 7** Maximum Continuous Drain Current  
 vs. Case Temperature

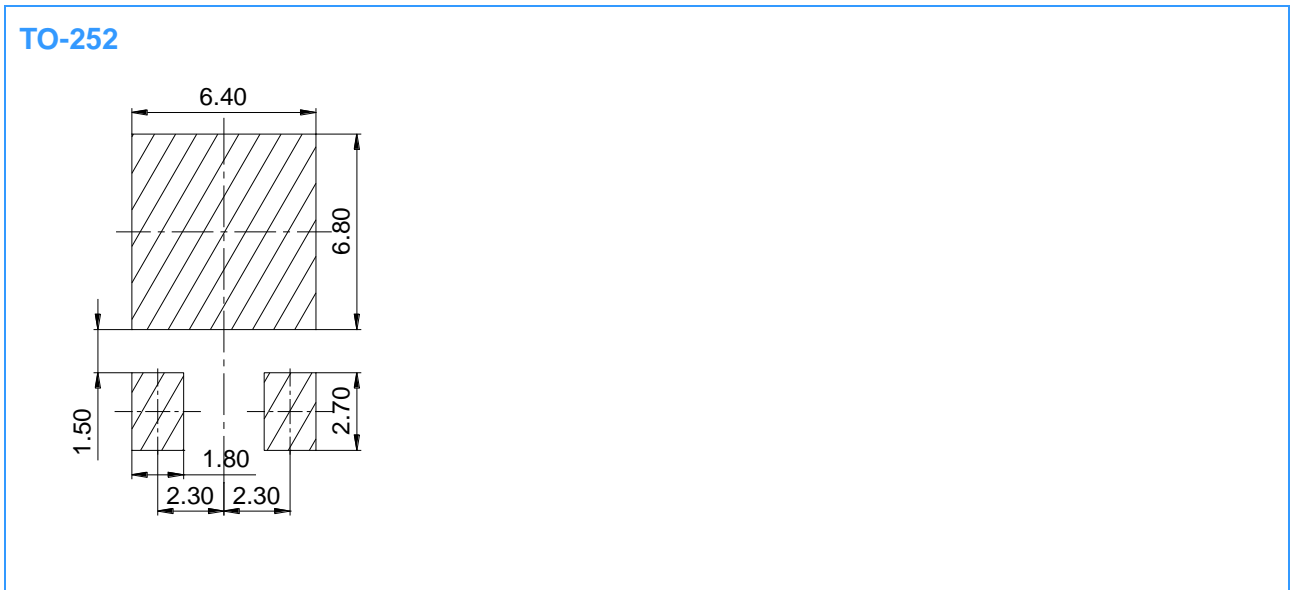


**Figure 8** Maximum Effective Transient Thermal  
 Impedance, Junction-to-Case

**Package Outline Dimensions** (Unit: mm)



**Mounting Pad Layout** (Unit: mm)



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